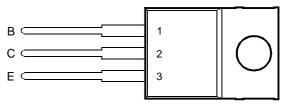
- Designed for Complementary Use with TIP115, TIP116 and TIP117
- 50 W at 25°C Case Temperature
- 4 A Continuous Collector Current
- Minimum h_{FE} of 500 at 4 V, 2 A

TO-220 PACKAGE (TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRACA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING			VALUE	UNIT
	TIP110		60	
Collector-base voltage (I _E = 0)	TIP111	V_{CBO}	80	V
	TIP112		100	
	TIP110		60	
Collector-emitter voltage (I _B = 0)	TIP111	V_{CEO}	80	V
	TIP112		100	
Emitter-base voltage			5	V
Continuous collector current			4	Α
Peak collector current (see Note 1)			6	Α
Continuous base current			50	mA
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)			50	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)			2	W
Unclamped inductive load energy (see Note 4)			25	mJ
Operating junction temperature range			-65 to +150	°C
Storage temperature range			-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds			260	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%.$
 - 2. Derate linearly to 150°C case temperature at the rate of 0.4 W/°C.
 - 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
 - 4. This rating is based on the capability of the transistor to operate safely in a circuit of: L = 20 mH, $I_{B(on)}$ = 5 mA, R_{BE} = 100 Ω , $V_{BE(off)}$ = 0, R_{S} = 0.1 Ω , V_{CC} = 20 V.



TIP110, TIP111, TIP112 NPN SILICON POWER DARLINGTONS

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electrical characteristics at 25°C case temperature

	PARAMETER		TEST CONDI	TIONS	MIN	TYP	MAX	UNIT
V _{(BR)CEO}	Collector-emitter breakdown voltage	I _C = 30 mA (see Note 5)	I _B = 0	TIP110 TIP111 TIP112	60 80 100			V
I _{CEO}	Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 40 \text{ V}$ $V_{CE} = 50 \text{ V}$	$I_{B} = 0$ $I_{B} = 0$ $I_{B} = 0$	TIP110 TIP111 TIP112			2 2 2	mA
I _{CBO}	Collector cut-off current	$V_{CB} = 60 \text{ V}$ $V_{CB} = 80 \text{ V}$ $V_{CB} = 100 \text{ V}$	$I_{E} = 0$ $I_{E} = 0$ $I_{E} = 0$	TIP110 TIP111 TIP112			1 1 1	mA
I _{EBO}	Emitter cut-off current	V _{EB} = 5 V	I _C = 0				2	mA
h _{FE}	Forward current transfer ratio	$V_{CE} = 4 V$ $V_{CE} = 4 V$	I _C = 1 A I _C = 2 A	(see Notes 5 and 6)	1000 500			
V _{CE(sat)}	Collector-emitter saturation voltage	I _B = 8 mA	I _C = 2 A	(see Notes 5 and 6)			2.5	V
V _{BE}	Base-emitter voltage	V _{CE} = 4 V	I _C = 2 A	(see Notes 5 and 6)			2.8	>
V _{EC}	Parallel diode forward voltage	I _E = 4 A	I _B = 0	(see Notes 5 and 6)			3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, t_p = 300 μ s, duty cycle \leq 2%.

resistive-load-switching characteristics at 25°C case temperature

	PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t _{on}	Turn-on time	I _C = 2 A	$I_{B(on)} = 8 \text{ mA}$	$I_{B(off)} = -8 \text{ mA}$		2.6		μs
t _{off}	Turn-off time	$V_{BE(off)} = -5 V$	$R_L = 15 \Omega$	$t_p = 20 \ \mu s, \ dc \le 2\%$		4.5		μs

 $^{^{\}dagger} \ \ \mbox{Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.}$

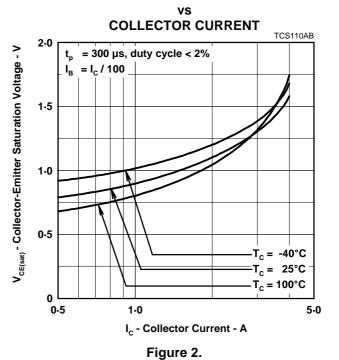
^{6.} These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

TYPICAL CHARACTERISTICS

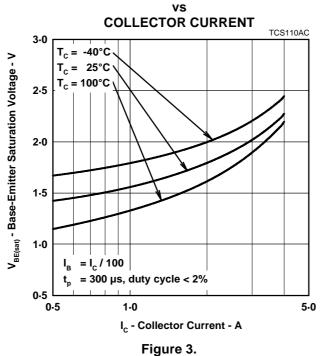
TYPICAL DC CURRENT GAIN COLLECTOR CURRENT TCS110AA 20000 $T_c = -40$ °C 25°C 10000 $T_c = 100$ °C h_{FE} - Typical DC Current Gain 1000 4 V = 300 μ s, duty cycle < 2% 100 0.5 1.0 5-0 I_C - Collector Current - A

Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE

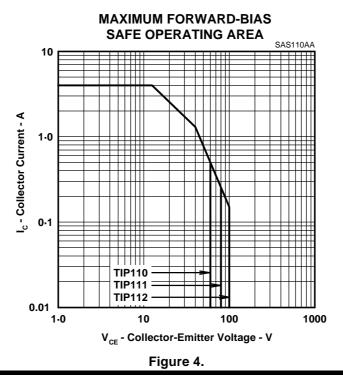


BASE-EMITTER SATURATION VOLTAGE





MAXIMUM SAFE OPERATING REGIONS



THERMAL INFORMATION

MAXIMUM POWER DISSIPATION

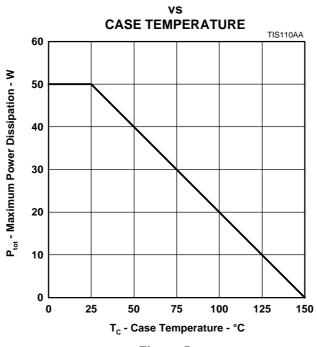


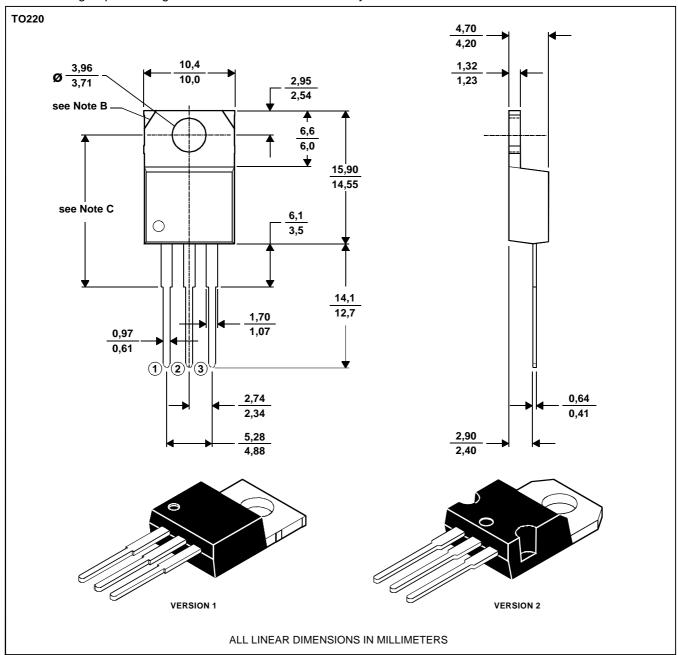
Figure 5.

MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTES: A. The centre pin is in electrical contact with the mounting tab.

B. Mounting tab corner profile according to package version.

C. Typical fixing hole centre stand off height according to package version. Version 1, 18.0 mm. Version 2, 17.6 mm. **MDXXBE**

TIP110, TIP111, TIP112 NPN SILICON POWER DARLINGTONS

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